



4NM50

Power MOSFET

4A, 500V N-CHANNEL SUPER-JUNCTION MOSFET

DESCRIPTION

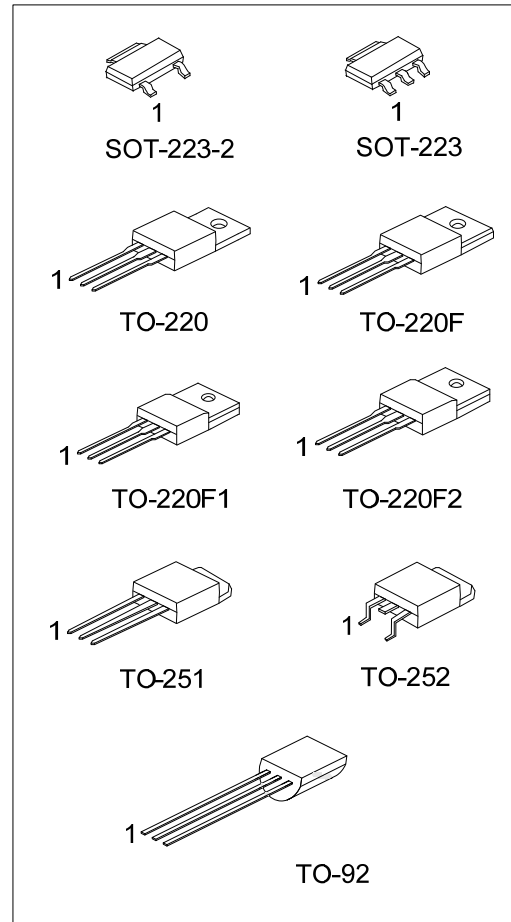
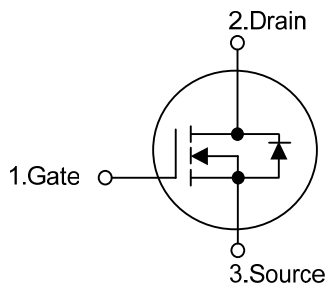
The UTC **4NM50** is a high voltage super junction MOSFET and is designed to have better characteristics.

The UTC **4NM50** Utilizing an advanced charge-balance technology, enhance system efficiency, improve EMI and reliability. such as low gate charge, low on-state resistance and have a high power density and high rugged avalanche characteristics. This super junction MOSFET usually used at AC/DC power conversion, and industrial power applications.

FEATURES

- * $R_{DS(ON)} \leq 1.3\Omega$ @ $V_{GS}=10V, I_D=2.0A$
- * Fast Switching Capability
- * Avalanche Energy Tested
- * Improved dv/dt Capability, High Ruggedness

SYMBOL



ORDERING INFORMATION

Ordering Number		Package	Pin Assignment			Packing
Lead Free	Halogen Free		1	2	3	
4NM50L-AA2-R	4NM50G-AA2-R	SOT-223-2	G	D	S	Tape Reel
4NM50L-AA3-R	4NM50G-AA3-R	SOT-223	G	D	S	Tape Reel
4NM50L-TA3-T	4NM50G-TA3-T	TO-220	G	D	S	Tube
4NM50L-TF1-T	4NM50G-TF1-T	TO-220F1	G	D	S	Tube
4NM50L-TF2-T	4NM50G-TF2-T	TO-220F2	G	D	S	Tube
4NM50L-TF3-T	4NM50G-TF3-T	TO-220F	G	D	S	Tube
4NM50L-TM3-T	4NM50G-TM3-T	TO-251	G	D	S	Tube
4NM50L-TN3-R	4NM50G-TN3-R	TO-252	G	D	S	Tape Reel
4NM50L-T92-B	4NM50G-T92-B	TO-92	G	D	S	Tape Box
4NM50L-T92-K	4NM50G-T92-K	TO-92	G	D	S	Bulk

Note: Pin Assignment: G: Gate D: Drain S: Source

<p>4NM50G-AA2-R</p> <p>(1) Packing Type (2) Package Type (3) Green Package</p>	<p>(1) T: Tube, R: Tape Reel (2) AA2: SOT-223-2, AA3: SOT-223, TA3: TO-220, TF1: TO-220F1, TF2: TO-220F2, TF3: TO-220F, TM3: TO-251, TN3: TO-252, T92: TO-92 (3) G: Halogen Free and Lead Free, L: Lead Free</p>
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MARKING

Package	Marking
SOT-223-2 / SOT-223	<p>Lot Code ← 4NM50 □ → Date Code</p> <p>1</p> <p>L: Lead Free G: Halogen Free</p>
TO-220F / TO-220F / TO-220F1 TO-220F2 / TO-251 / TO-252	<p>UTC Lot Code ← 4NM50 □ → Date Code</p> <p>1</p> <p>L: Lead Free G: Halogen Free</p>
TO-92	<p>UTC Lot Code ← 4NM50 □ → Date Code</p> <p>1</p> <p>L: Lead Free G: Halogen Free</p>

■ ABSOLUTE MAXIMUM RATINGS ($T_C = 25^\circ\text{C}$, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		V_{DSS}	500	V
Gate-Source Voltage		V_{GSS}	± 30	V
Drain Current	Continuous	I_D	4	A
	Pulsed (Note 2)	I_{DM}	8	A
Avalanche Current (Note 2)		I_{AR}	1.7	A
Avalanche Energy	Single Pulsed (Note 3)	E_{AS}	38	mJ
Peak Diode Recovery dv/dt (Note 4)		dv/dt	3.5	V/ns
Power Dissipation	SOT-223-2/SOT-223	P_D	5	W
	TO-220		85	W
	TO-220F/TO-220F1		28	W
	TO-220F2		30	W
	TO-251/TO-252		52	W
	TO-92		1.78	W
Junction Temperature		T_J	+150	$^\circ\text{C}$
Storage Temperature		T_{STG}	-55 ~ +150	$^\circ\text{C}$

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. Repetitive Rating : Pulse width limited by maximum junction temperature.

3. $L=10\text{mH}$, $I_{AS}=2.76\text{A}$, $V_{DD}=50\text{V}$, $R_G=25\ \Omega$, Starting $T_J = 25^\circ\text{C}$

4. $I_{SD}\leq 4.0\text{A}$, $di/dt\leq 200\text{A}/\mu\text{s}$, $V_{DD}\leq BV_{DSS}$, Starting $T_J = 25^\circ\text{C}$

■ THERMAL DATA

PARAMETER		SYMBOL	RATING	UNIT
Junction to Ambient	SOT-223-2/SOT-223	θ_{JA}	150	$^\circ\text{C}/\text{W}$
	TO-220/TO-220F		62.5	$^\circ\text{C}/\text{W}$
	TO-220F1/TO-220F2			
	TO-251/TO-252			
	TO-92			$^\circ\text{C}/\text{W}$
Junction to Case	SOT-223-2/SOT-223	θ_{JC}	25	$^\circ\text{C}/\text{W}$
	TO-220		1.47	$^\circ\text{C}/\text{W}$
	TO-220F/TO-220F1		4.46	$^\circ\text{C}/\text{W}$
	TO-220F2		4.16	$^\circ\text{C}/\text{W}$
	TO-251/TO-252		2.4	$^\circ\text{C}/\text{W}$
	TO-92		70	$^\circ\text{C}/\text{W}$

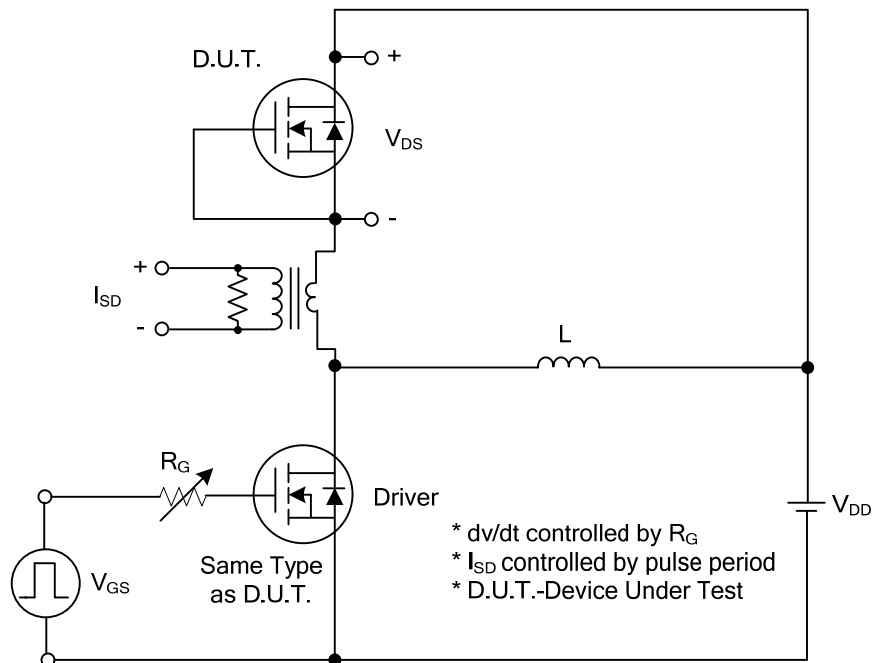
■ ELECTRICAL CHARACTERISTICS (T_J=25°C, unless otherwise specified)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} = 0V, I _D = 250μA	500			V
Drain-Source Leakage Current	I _{DSS}	V _{DS} = 500V, V _{GS} = 0V			10	μA
Gate- Source Leakage Current	Forward	V _{GS} = 30V, V _{DS} = 0V			100	nA
	Reverse		V _{GS} = -30V, V _{DS} = 0V			-100
ON CHARACTERISTICS						
Gate Threshold Voltage	V _{GS(TH)}	V _{DS} = V _{GS} , I _D = 250μA	2.5		4.5	V
Static Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} = 10V, I _D = 2.0A			1.3	Ω
DYNAMIC CHARACTERISTICS						
Input Capacitance	C _{ISS}	V _{GS} =0V, V _{DS} =25V, f=1.0 MHz		215		pF
Output Capacitance	C _{OSS}			205		pF
Reverse Transfer Capacitance	C _{RSS}			27		pF
SWITCHING CHARACTERISTICS						
Total Gate Charge (Note 1)	Q _G	V _{DS} =400V, V _{GS} =10V, I _D =4A, I _G =100μA(Note1,2)		26		nC
Gate to Source Charge	Q _{GS}			2.5		nC
Gate to Drain Charge	Q _{GD}			3.4		nC
Turn-ON Delay Time (Note 1)	t _{D(ON)}	V _{DD} =100V, V _{GS} =10V, I _D =4A, R _G =25Ω(Note1,2)		4		ns
Rise Time	t _R			18		ns
Turn-OFF Delay Time	t _{D(OFF)}			30		ns
Fall-Time	t _F			26		ns
SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS						
Maximum Body-Diode Continuous Current	I _S				4	A
Maximum Body-Diode Pulsed Current	I _{SM}				8	A
Drain-Source Diode Forward Voltage (Note 1)	V _{SD}	I _S =4.0A, V _{GS} =0V			1.4	V
Body Diode Reverse Recovery Time (Note 1)	t _{rr}	I _S =4.0A, V _{GS} =0V, di/dt=100A/μs		210		ns
Body Diode Reverse Recovery Charge	Q _{rr}				1.52	

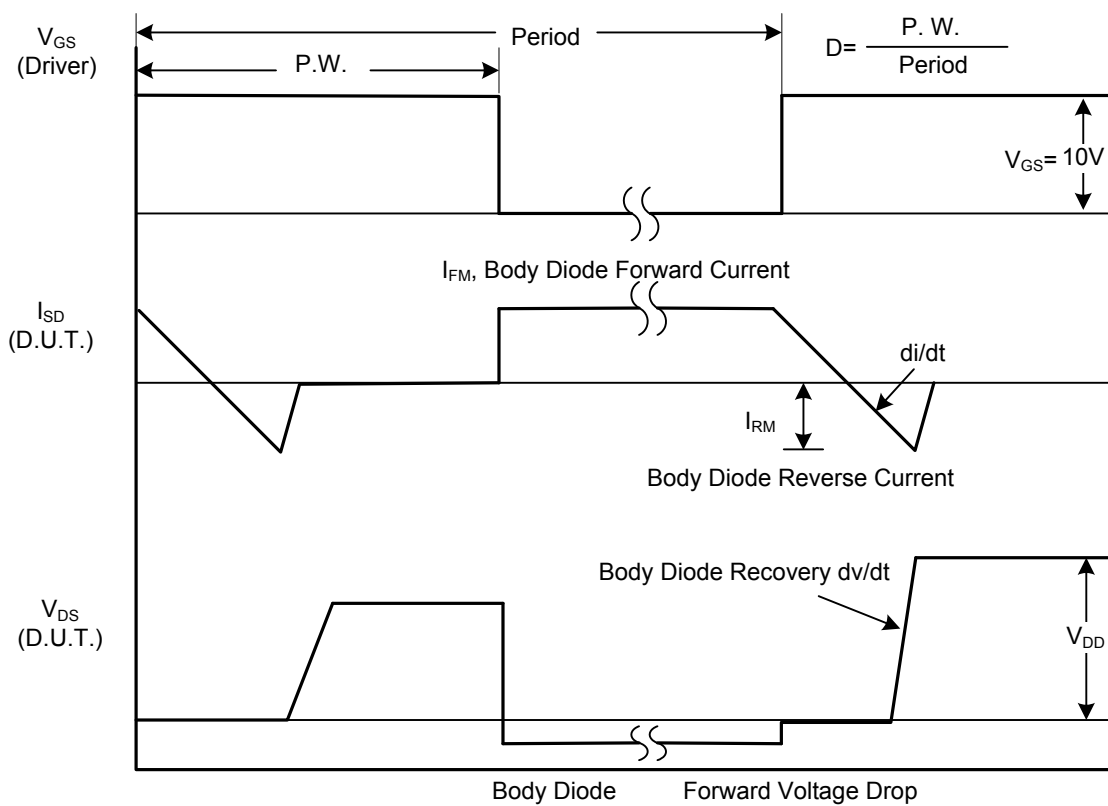
Notes: 1. Pulse Test: Pulse width ≤ 300μs, Duty cycle ≤ 2%.

2. Essentially independent of operating temperature.

TEST CIRCUITS AND WAVEFORMS

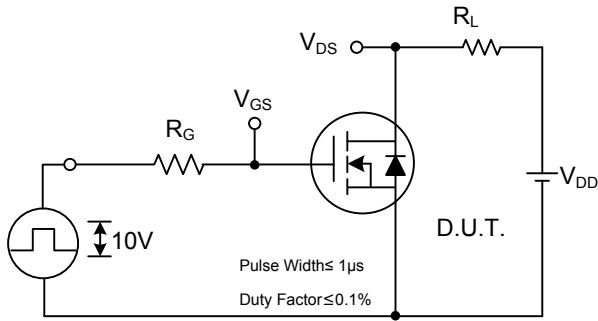


Peak Diode Recovery dv/dt Test Circuit

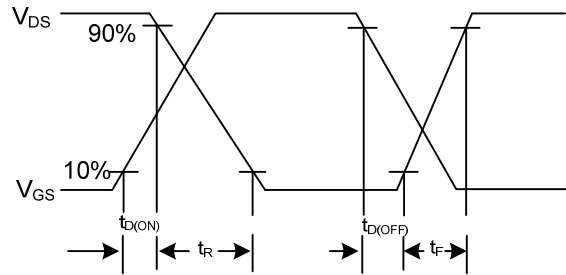


Peak Diode Recovery dv/dt Waveforms

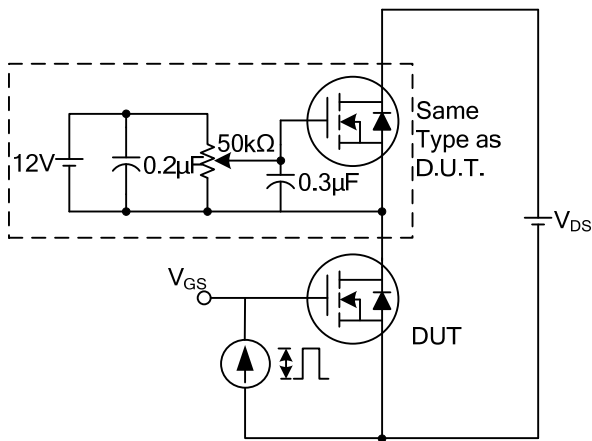
TEST CIRCUITS AND WAVEFORMS (Cont.)



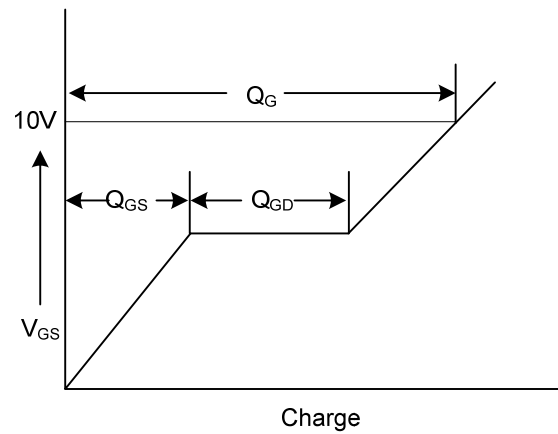
Switching Test Circuit



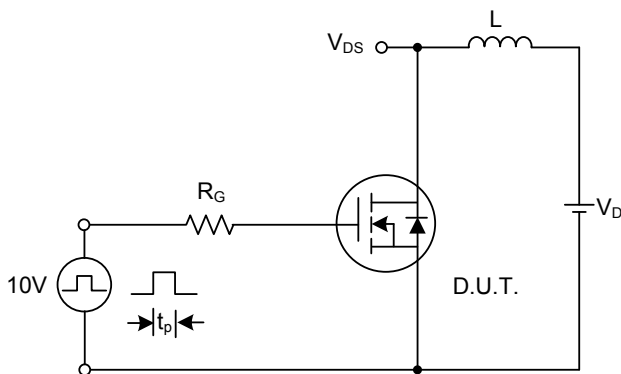
Switching Waveforms



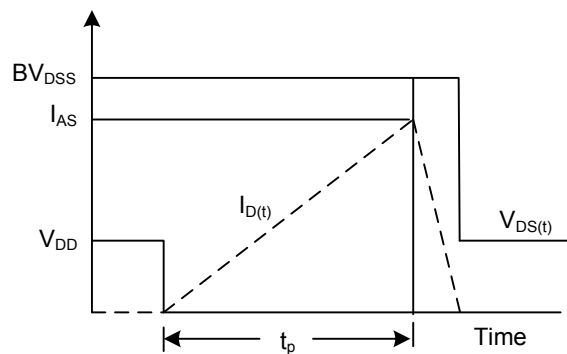
Gate Charge Test Circuit



Gate Charge Waveform

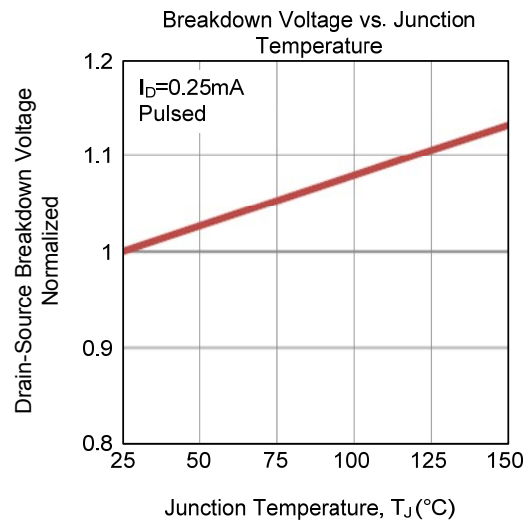
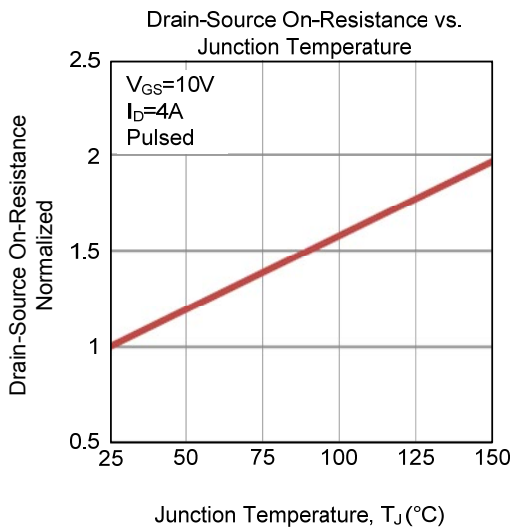
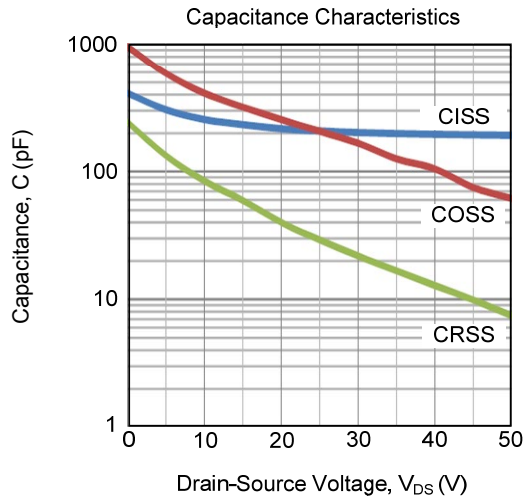
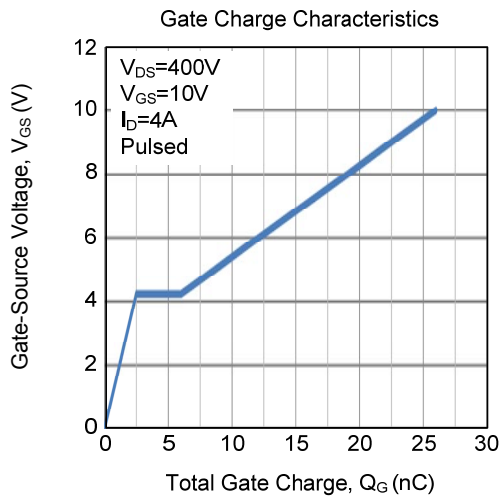
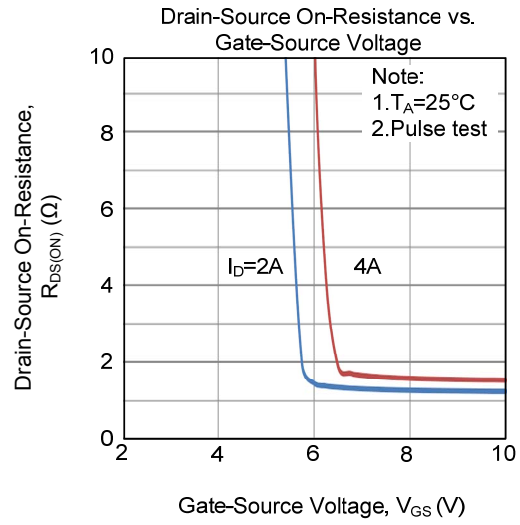
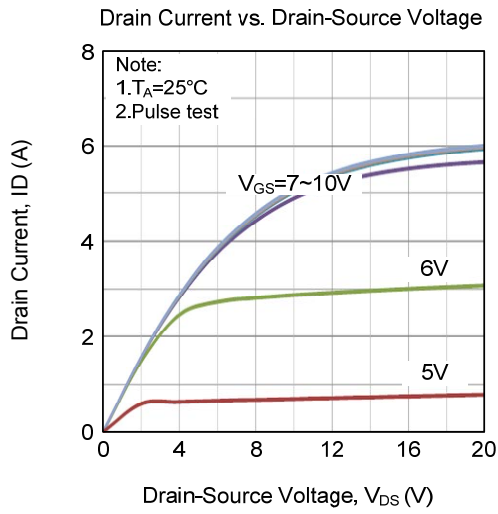


Unclamped Inductive Switching Test Circuit

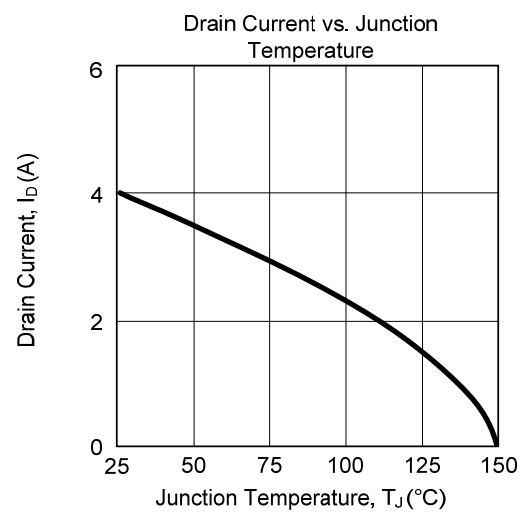
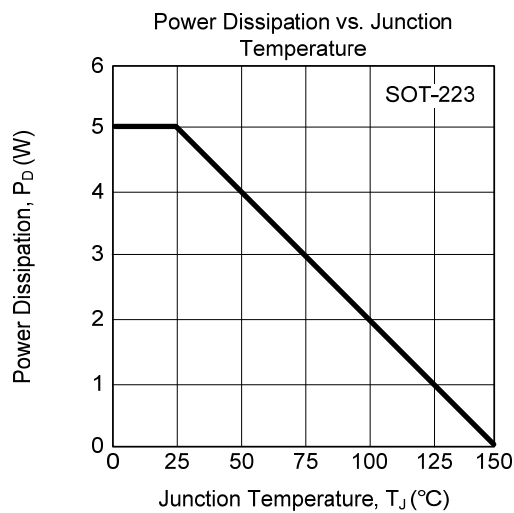
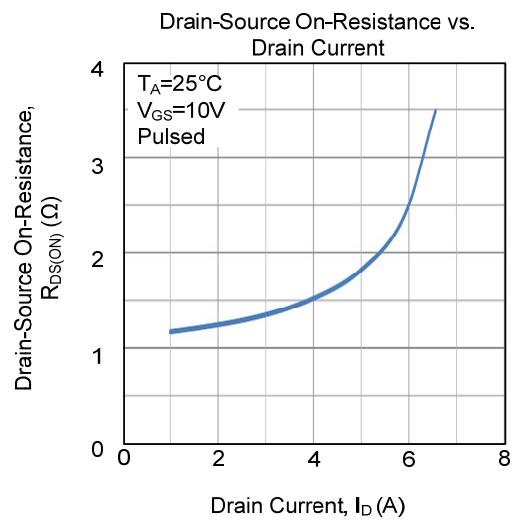
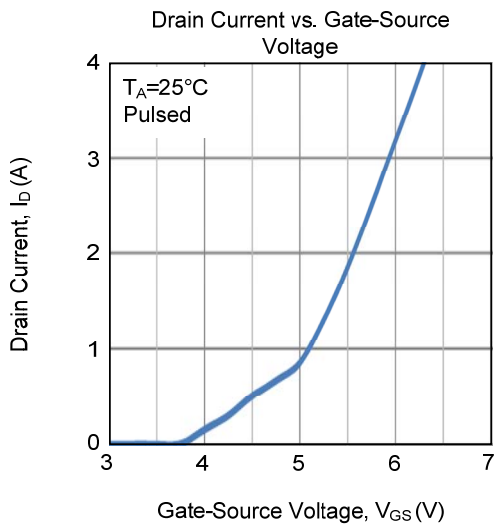
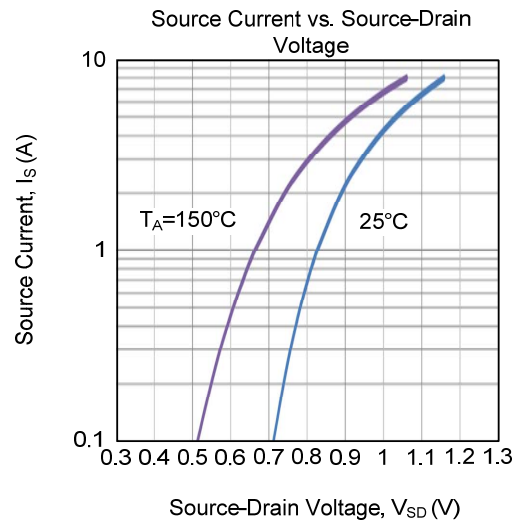
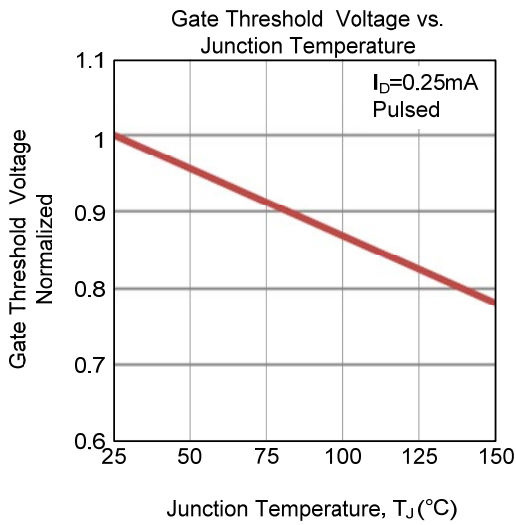


Unclamped Inductive Switching Waveforms

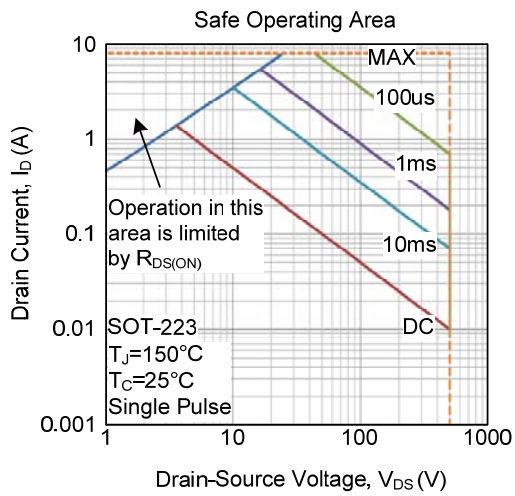
TYPICAL CHARACTERISTICS



■ TYPICAL CHARACTERISTICS (Cont.)



■ TYPICAL CHARACTERISTICS (Cont.)



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